AMPMODU | AMPMODU Headers

TE Internal #: 4-146486-0

PCB Mount Header, Vertical, Board-to-Board, 80 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder,

AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 80

Number of Rows: 2

Features

Product Type Features

PCB Connector Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Unshrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

Configuration Features

Board-to-Board Configuration	Parallel
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	80
Number of Rows	2

Electrical Characteristics

Insulation Resistance 5000 M Ω

Body Features

Primary Product Color	Black	
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Contact Features

Contact Mating Area Plating Material Inickness 2.54 – 5.08 µm[100 – 200 µin]	Mating Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]	
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Mating Course Post Dimension	44 mm[025 in]
Mating Square Post Dimension	.64 mm[.025 in]
Carata at Chara a 2 Farms	100 – 200 μin
Contact Shape & Form	Square
Contact Mating Area Length	2.79 mm[.109 in]
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Mating Area Plating Material	Tin-Lead
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Termination Post & Tail Length	3.12 mm[.123 in]
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	Without
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	7.62 mm[.3 in]
PCB Thickness (Recommended)	1.4 mm[.055 in]
Usage Conditions	
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Assembly Process Feature	None
Circuit Application	Signal
Industry Standards	
Compatible With Approved Standards Products	CSA LR7189, UL E28476



UL Flammability Rating UL 94V-0

Packaging Features

Packaging Quantity	75
Packaging Method	Carton

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) SVHC > Threshold: Pb (13% in 4690971277) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





Also in the Series | AMPMODU Headers



Automotive Headers(1)



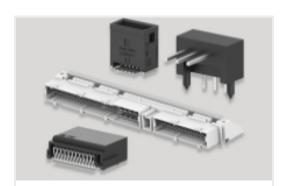
Board-to-Board Headers & Receptacles(1576)



Connector Contacts(47)



Connector Hardware(1)



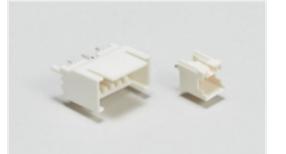
PCB Headers & Receptacles(1621)



Rectangular Power Connectors(43)



Wire-to-Board Connector Assemblies & Housings(5)



Wire-to-Board Headers & Receptacles (114)

Customers Also Bought



Documents

Product Drawings
80 MODII HDR DRST UNSHRD STKG

English

Datasheets & Catalog Pages
AMPMODU Interconnetion System

PCB Mount Header, Vertical, Board-to-Board, 80 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Tin-Lead, Through Hole - Solder, AMPMODU Headers



AMPMODU Interconnetion System

English